



	CPC1035N	Units
Blocking Voltage	350	V _P
Load Current	100	mA
Max On-resistance	30	Ω

Features

- Small 4 Pin SOP Package
- Low Drive Power Requirements (TTL/CMOS Compatible)
- No Moving Parts
- High Reliability
- Arc-Free With No Snubbing Circuits
- 1500V_{rms} Input/Output Isolation
- No EMI/RFI Generation
- Machine Insertable, Wave Solderable
- Tape & Reel Version Available

Applications

- Telecommunications
 - Telecom Switching
 - Tip/Ring Circuits
 - Modem Switching (Laptop, Notebook, Pocket Size)
 - Hook Switch
 - Dial Pulsing
 - Ground Start
 - Ringing Injection
- Instrumentation
 - Multiplexers
 - Data Acquisition
 - Electronic Switching
 - I/O Subsystems
 - Meters (Watt-Hour, Water, Gas)
- Medical Equipment—Patient/Equipment Isolation
- Security
- Aerospace
- Industrial Controls

Description

The CPC1035N is a miniature 1-Form-A solid state relay in a 4 pin SOP package that employs optically coupled MOSFET technology to provide 1500V_{rms} of input to output isolation. The efficient MOSFET switches and photovoltaic die use Clare's patented OptoMOS® architecture. The optically coupled input is controlled by a highly efficient GaAlAs infrared LED. The CPC1035N uses Clare's state of the art double molded vertical construction packaging to produce the world's smallest relay. The CPC1035N offers board space savings of at least 20% over the competitor's larger 4 pin SOP relay.

Approvals

- UL Recognized Component
File #: E76270
- Certified to: EN60950 and IEC950

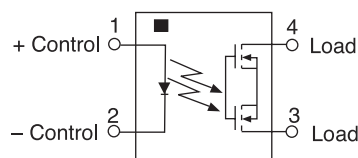
Ordering Information

Part #	Description
CPC1035N	4 Pin SOP (100/tube)
CPC1035NTR	4 Pin SOP (2000/reel) picked from pin 1 side
CPC1035NTR-1	4 Pin SOP (100/tube) picked from pin 3 side

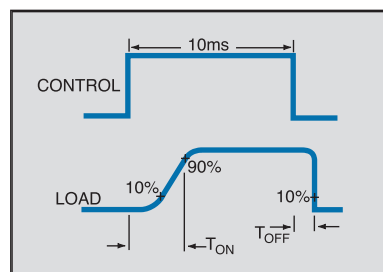
* For other packaging options consult factory.

Pin Configuration

CPC1035N Pinout



Switching Characteristics of Normally Open (Form A) Devices



Absolute Maximum Ratings (@ 25° C)

Parameter	Ratings	Units
Blocking Voltage	350	V _P
Reverse Input Voltage	5	V
Input control Current	50	mA
Peak (10ms)	1	A
Input Power Dissipation	150	mW
Total Power Dissipation	400 ¹	mW
Isolation voltage Input to Output	1500	V _{rms}
Operational Temperature	-40 to +85	°C
Storage Temperature	-40 to +125	°C
Soldering Temperature (10 seconds Max.)	+220	°C

¹ Derate Linearly 3.33 mw / °C

Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.

Electrical Characteristics

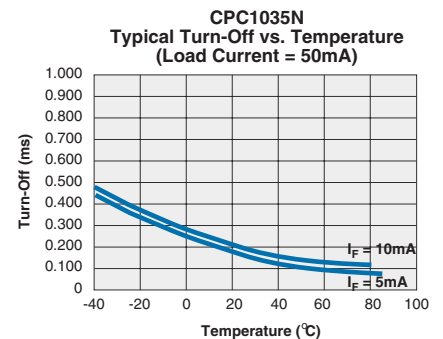
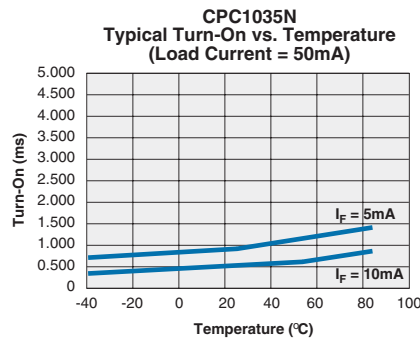
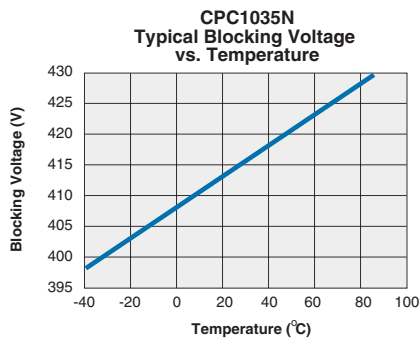
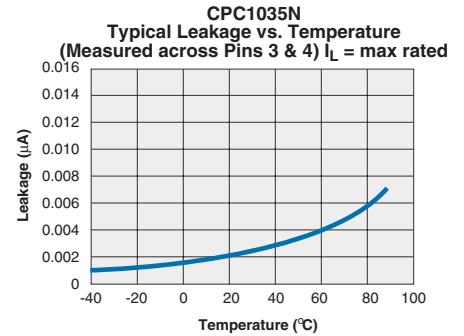
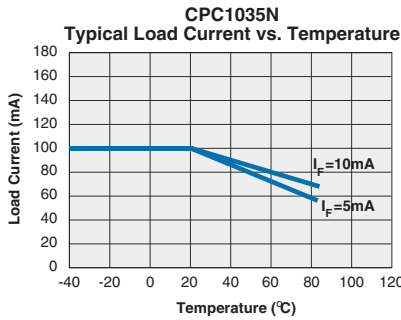
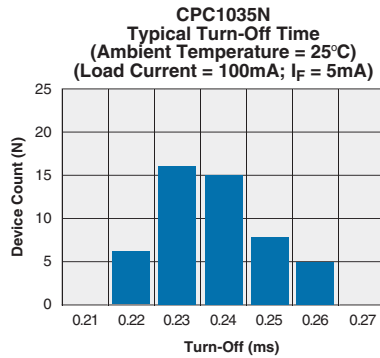
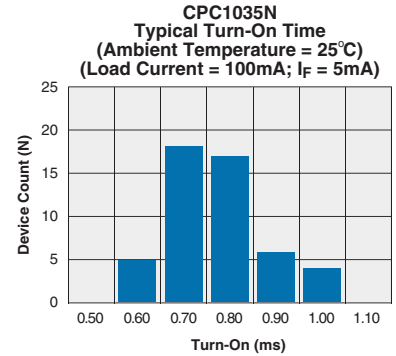
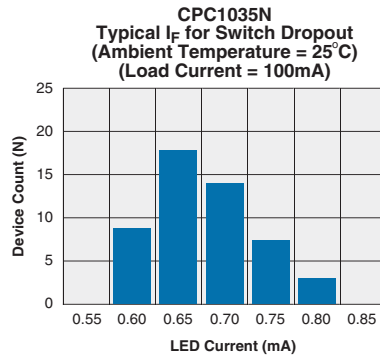
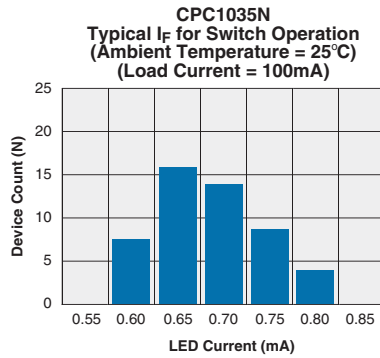
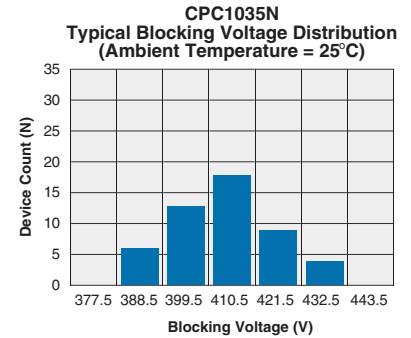
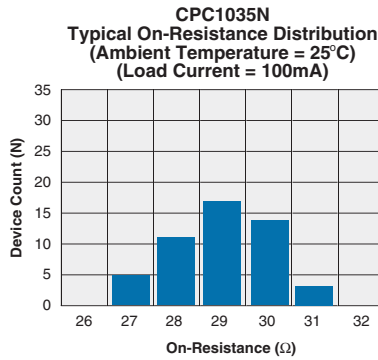
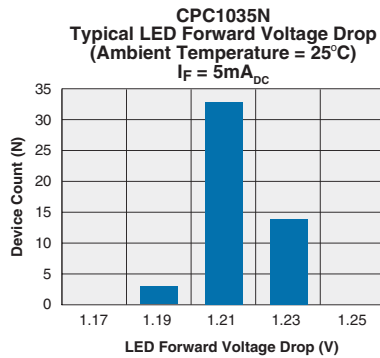
Parameter	Conditions	Symbol	Min	Typ	Max	Units
Output Characteristics @ 25°C						
Load Current ¹	Continuous	I _L	-	-	100	mA
Peak Load Current	10ms	I _{LPK}	-	-	350	mA
On-Resistance ²	I _L =100mA	R _{ON}	-	30	35	Ω
Off-State Leakage Current	V _L =350V	I _{LEAK}	-	-	1	μA
Switching Speeds	I _F =5mA, V _L =10V	T _{ON}	-	-	2	ms
Turn-On	I _F =5mA, V _L =10V	T _{OFF}	-	-	1.0	ms
Output Capacitance	50V; f=1MHz	C _{OUT}	-	25	-	pF
Input Characteristics @ 25°C						
Input Control Current ³	I _L =100mA	I _F	2	-	-	mA
Input Dropout Current	-	I _F	0.3	0.9	-	mA
Input Voltage Drop	I _F =5mA	V _F	0.9	1.2	1.4	V
Reverse Input Current	V _R =5V	I _R	-	-	10	μA
Input to Output Characteristics @ 25°C						
Capacitance Input to Output	-	-	-	1	-	pF

¹ Load current derates linearly from 100mA @ 25°C to 70mA @ 85°C.

² Measurement taken within 1 second of on time.

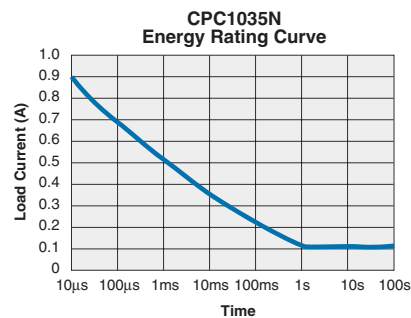
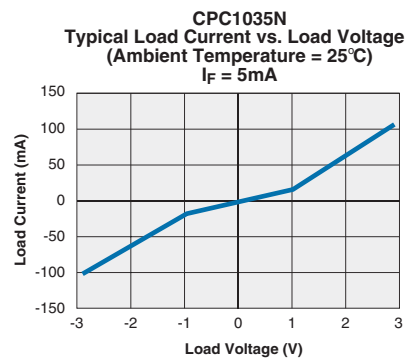
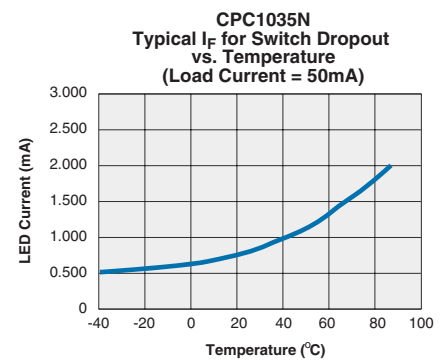
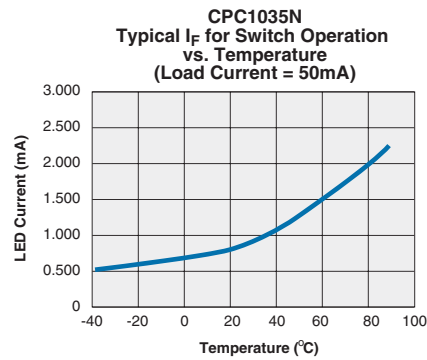
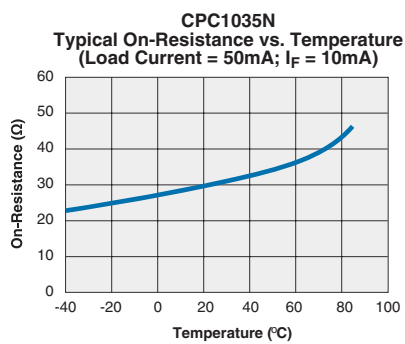
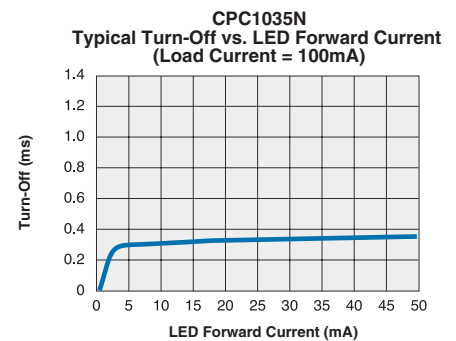
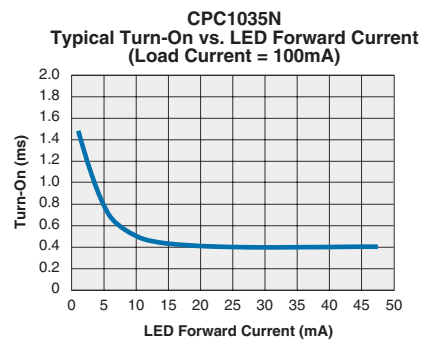
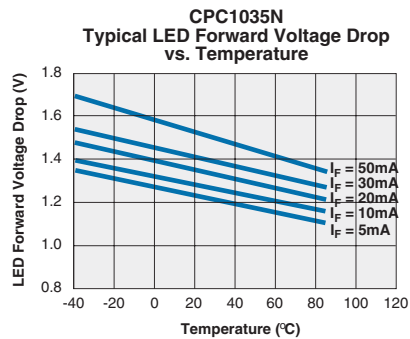
³ For applications requiring high temperature operation (greater than 60°C) an LED drive current of 10mA is recommended.

PERFORMANCE DATA*



*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

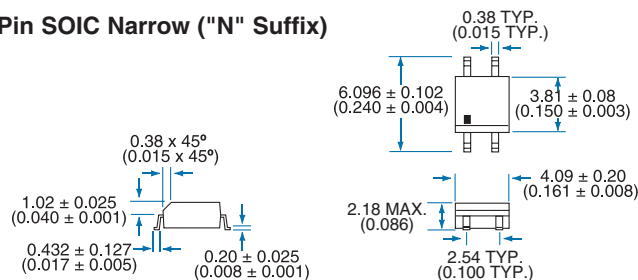
PERFORMANCE DATA*



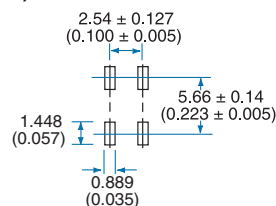
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PERFORMANCE DATA*

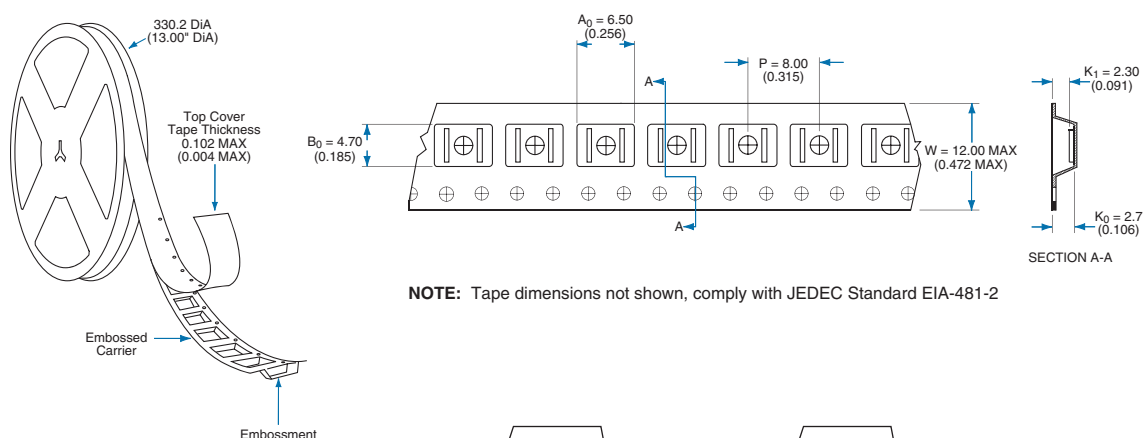
4 Pin SOIC Narrow ("N" Suffix)



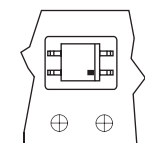
PC Board Pattern (Top View)



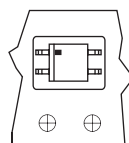
Tape and Reel Packaging for 4 pin SOIC package



NOTE: Tape dimensions not shown, comply with JEDEC Standard EIA-481-2



CPC1035NTR



CPC1035NTR-1

Dimensions:
mm
(inches)

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